# High and Low Side Driver

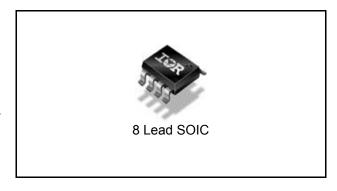
#### Features

- Floating channel designed for bootstrap operation
- Fully operational to +600V
- Tolerant to negative transient voltage
- dV/dt immune
- Gate drive supply range from 10 to 20V
- Undervoltage lockout for both channels
- 3.3V, 5V and 15V input logic compatible
- Matched propagation delay for both channels
- Logic and power ground +/-5V offset
- Lower di/dt gate driver for better noise immunity
- Outputs in phase with inputs

### Product Summary

VOFFSET	600V max.
I <sub>O+/-</sub>	200 mA / 350 mA
V <sub>OUT</sub>	10 – 20V
Ton/off (typ.)	220 & 200 ns

### **Package Options**



#### Description

The IR25604 is a high voltage, high speed power MOSFET and IGBT driver with independent high and low side referenced output channels. Proprietary HVIC and latch immune CMOS technologies enable ruggedized monolithic construction. The logic input is compatible with standard CMOS or LSTTL output, down to 3.3V logic. The output drivers feature a high pulse current buffer stage designed for minimum driver cross-conduction. The floating channel can be used to drive an N-channel power MOSFET or IGBT in the high side configuration which operates up to 600 V.

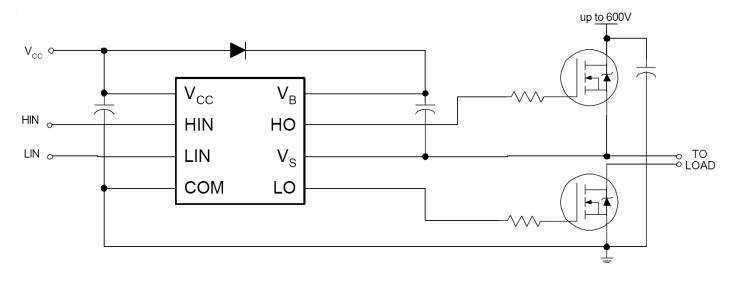
#### **Ordering Information**

Deer Deet Newslaw		Standard Pack		
Base Part Number	Package Type	Form	Quantity	Orderable Part Number
IR25604SPBF	SO8N	Tube	95	IR25604SPBF
IR25604SPBF	SO8N	Tape and Reel	2500	IR25604STRPBF

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### **Typical Connection Diagram**





#### **Absolute Maximum Ratings**

Absolute maximum ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions.

Symbol	Definition	Min.	Max.	Units
VB	High side floating absolute voltage	-0.3	625	
Vs	High side floating supply offset voltage	V <sub>B</sub> - 25	V <sub>B</sub> + 0.3	
V <sub>HO</sub>	High side floating output voltage	V <sub>S</sub> - 0.3	V <sub>B</sub> + 0.3	V
V <sub>CC</sub>	Low side and logic fixed supply voltage	-0.3	25	
V <sub>LO</sub>	Low side output voltage	-0.3	V <sub>CC</sub> + 0.3	
V <sub>IN</sub>	Logic input voltage	-0.3	V <sub>CC</sub> + 0.3	
dVs/dt	Allowable offset supply voltage transient	—	50	V/ns
PD	Package power dissipation @ TA ≤ +25°C	—	0.625	w
Rth <sub>JA</sub>	Thermal resistance, junction to ambient	—	200	°C/W
TJ	Junction temperature	—	150	
Τ <sub>S</sub>	Storage temperature	-55	150	°C
ΤL	Lead temperature (soldering, 10 seconds)		300	

#### **Recommended Operating Conditions**

For proper operation the device should be used within the recommended conditions. The  $V_S$  offset rating is tested with all supplies biased at 15V differential.

Symbol	Definition	Min.	Max.	Units
VB	High side floating supply absolute voltage	V <sub>S</sub> + 10	V <sub>S</sub> + 20	
Vs	High side floating supply offset voltage	+	600	
V <sub>HO</sub>	High side floating output voltage	V <sub>S</sub>	VB	v
V <sub>CC</sub>	Low side and logic fixed supply voltage	10	20	Ť
V <sub>LO</sub>	Low side output voltage	0	V <sub>CC</sub>	
VIN	Logic input voltage	0	V <sub>CC</sub>	
T <sub>A</sub>	Ambient temperature	-40	125	°C

<sup>+</sup> Logic operational for  $V_S$  of -5 to +600V. Logic state held for  $V_S$  of -5V to -VBS. (Please refer to Design Tip DT97-3 for more details).

### **Dynamic Electrical Characteristics**

 $V_{BIAS}$  (V<sub>CC</sub>, V<sub>BS</sub>) = 15V, CL = 1000 pF and T<sub>A</sub> = 25°C unless otherwise specified.

Symbol	Definition	Min.	Тур.	Max.	Units	Test Conditions
t <sub>on</sub>	Turn-on propagation delay	—	220	300		$V_{\rm S}$ = 0V
t <sub>off</sub>	Turn-off propagation delay	_	200	280		$V_{\rm S}$ = 0V or 600V
tr	Turn-on rise time		150	220	ns	$V_{\rm S}$ = 0V
t <sub>f</sub>	Turn-off fall time		50	80		$V_{\rm S}$ = 0V
MT	Delay matching, HS & LS turn-on/off	_	0	30		

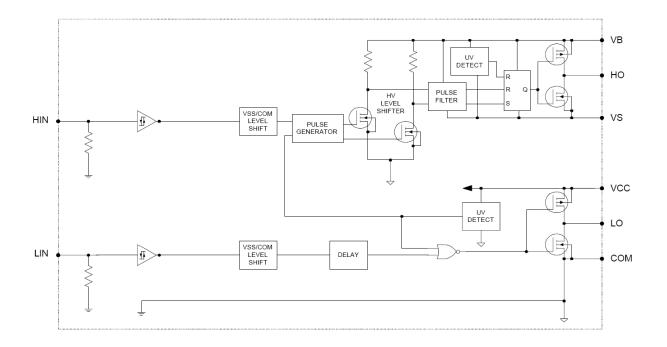
### **Static Electrical Characteristics**

 $V_{BIAS}$  (V<sub>CC</sub>, V<sub>BS</sub>) = 15V and T<sub>A</sub> = 25°C unless otherwise specified. The V<sub>IN</sub>, V<sub>TH</sub> and I<sub>IN</sub> parameters are referenced to COM. The V<sub>O</sub> and I<sub>O</sub> parameters are referenced to COM and are applicable to the respective output leads: HO and LO.

Symbol	Definition	Min.	Тур.	Max.	Units	Test Conditions
VIH	Logic "1" input voltage	2.9		_		V <sub>CC</sub> = 10V to 20V
VIL	Logic "0" input voltage	_		0.8	v	V <sub>CC</sub> = 10V to 20V
V <sub>OH</sub>	High level output voltage, $V_{BIAS}$ - $V_O$	_	0.8	1.4	v	l <sub>O</sub> = 20 mA
V <sub>OL</sub>	Low level output voltage, V <sub>O</sub>	_	0.3	0.6		l <sub>O</sub> = 20 mA
I <sub>LK</sub>	Offset supply leakage current	—		50		$V_{B} = V_{S} = 600V$
I <sub>QBS</sub>	Quiescent V <sub>BS</sub> supply current	20	75	130		$V_{IN} = 0V \text{ or } 5V$
IQCC	Quiescent V <sub>CC</sub> supply current	60	120	180	μA	V <sub>IN</sub> = 0V or 5V
I <sub>IN+</sub>	Logic "1" input bias current	—	5	20		V <sub>IN</sub> = 5V
I <sub>IN-</sub>	Logic "0" input bias current	_		2		$V_{IN} = 0V$
V <sub>CCUV+</sub> V <sub>BSUV+</sub>	$V_{CC}$ and $V_{BS}$ supply undervoltage positive going threshold	8	8.9	9.8		
V <sub>CCUV-</sub> V <sub>BSUV-</sub>	$V_{CC}$ and $V_{BS}$ supply undervoltage negative going threshold	7.4	8.2	9	V	
V <sub>CCUVH</sub> V <sub>BSUVH</sub>	Hysteresis	0.3	0.7			
I <sub>O+</sub>	Output high short circuit pulsed current	120	200		mA	V <sub>O</sub> = 0V PW ≤ 10 µs
I <sub>O-</sub>	Output low short circuit pulsed current	250	350	_		V <sub>O</sub> = 15V PW ≤ 10 µs



### **Functional Block Diagram**

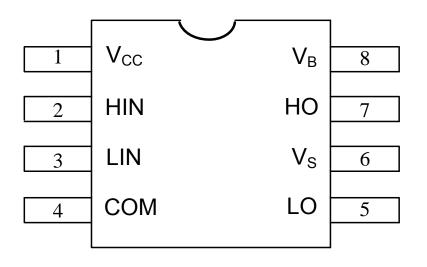




### Lead Definitions

Symbol	Description	
HIN	Logic input for high side gate driver outputs (HO), in phase	
LIN	ogic input for high side gate driver outputs (LO), in phase	
VB	High side floating supply	
HO	High side gate drive output	
VS	High side floating supply return	
V <sub>CC</sub>	Low side and logic fixed supply	
LO	Low side gate drive output	
COM	Low side return	

### Lead Assignments





### **Application Information and Additional Details**

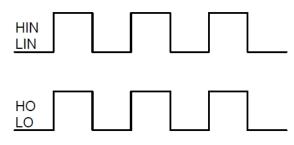
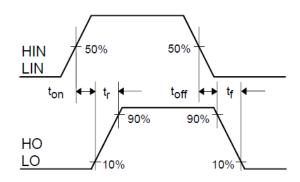
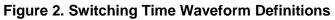


Figure 1. Input/Output Timing Diagram





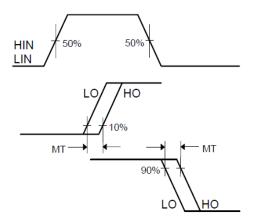
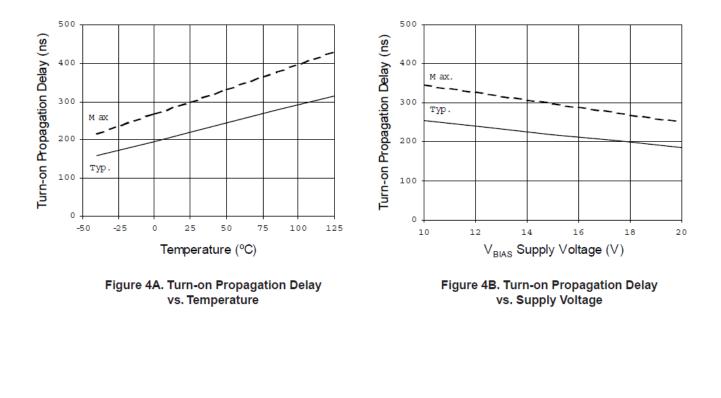
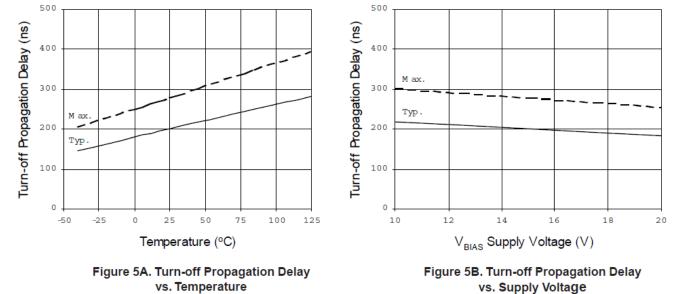


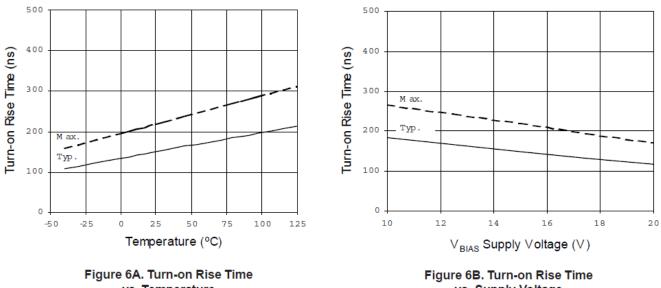
Figure 3. Delay Matching Waveform Definitions



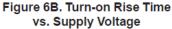








vs. Temperature



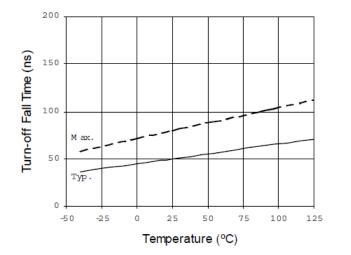


Figure 7A. Turn-off Fall Time vs. Temperature

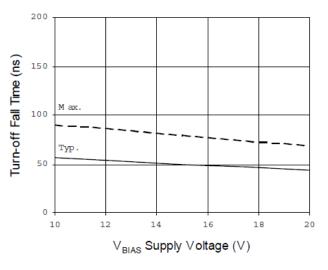
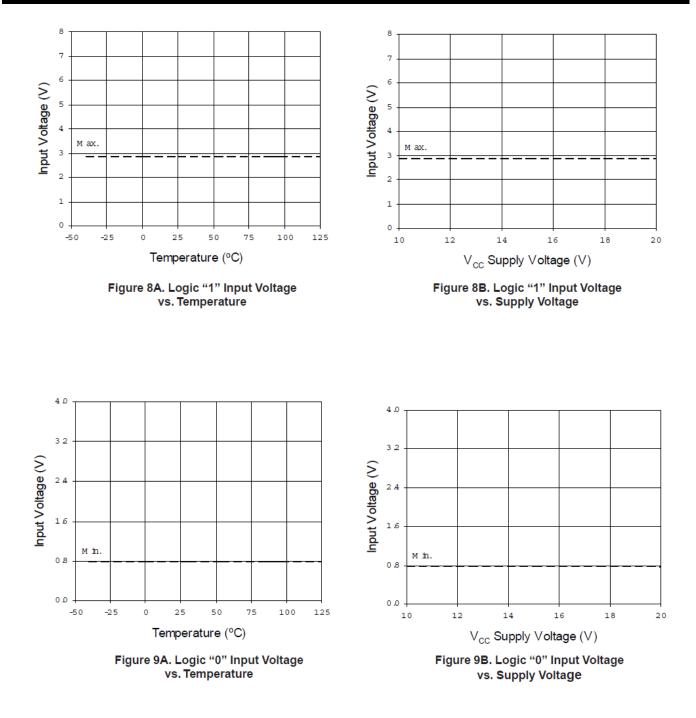


Figure 7B. Turn-off Fall Time vs. Supply Voltage







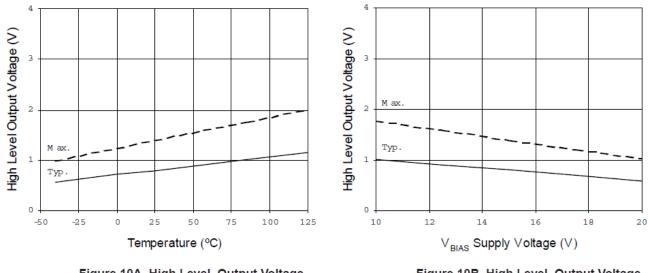
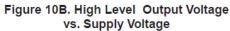


Figure 10A. High Level Output Voltage vs. Temperature



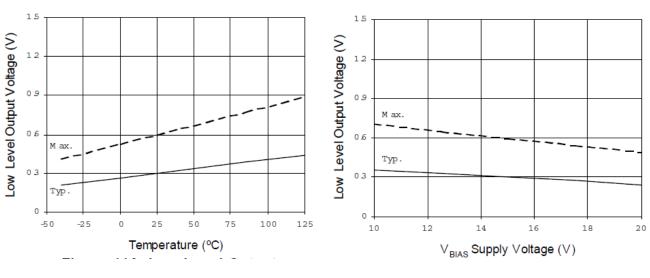
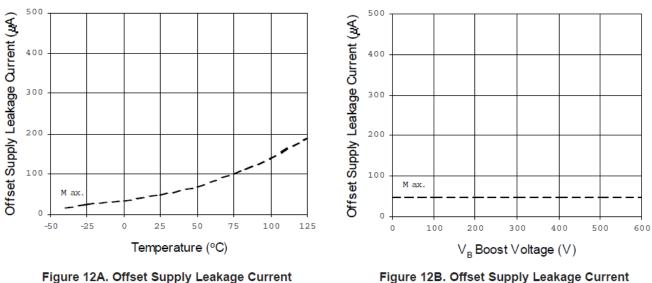


Figure 11A. Low Level Output Voltage vs. Temperature

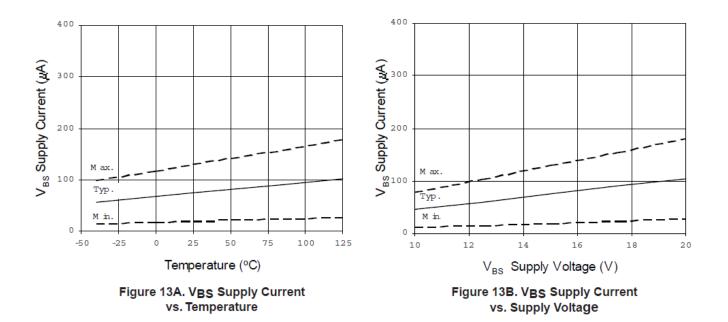
Figure 11B. Low Level Output Voltage vs. Supply Voltage



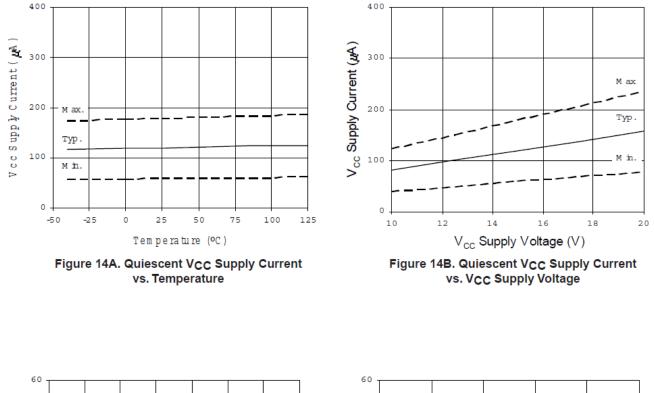


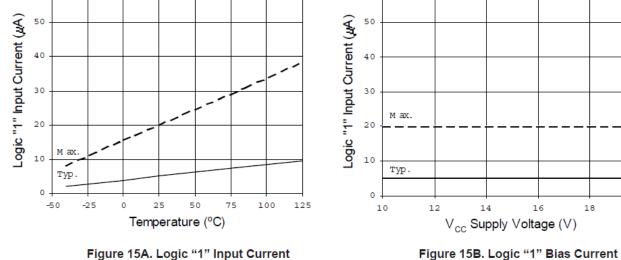
vs. Temperature









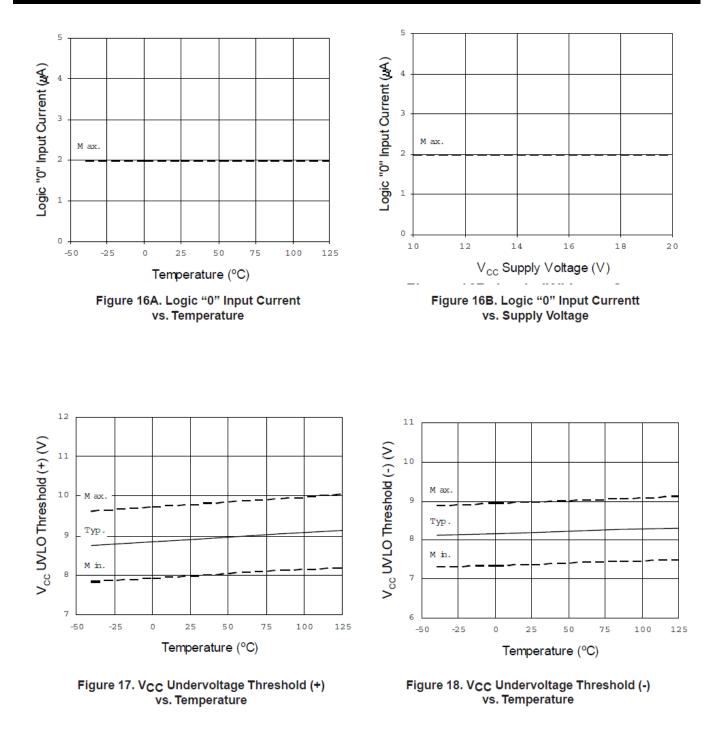


vs. Supply Voltage

vs. Temperature

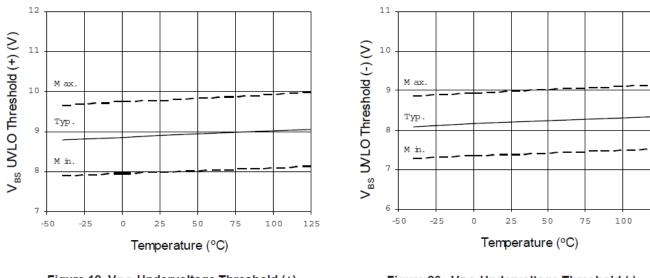
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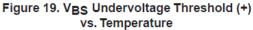


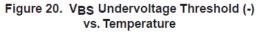


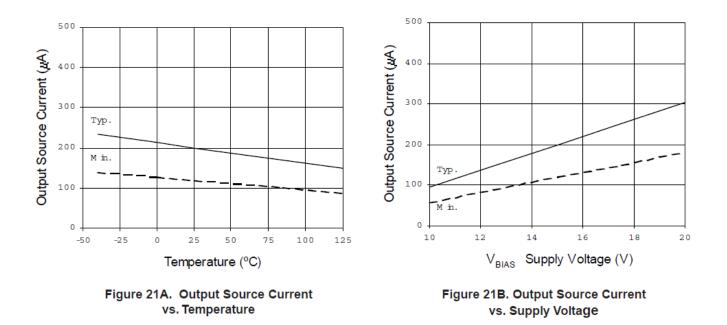


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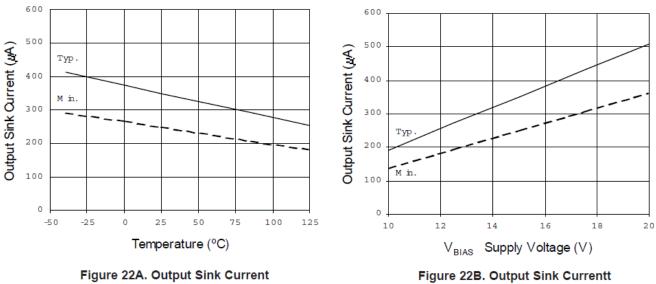




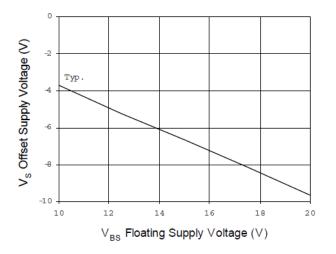


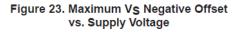






vs. Temperature

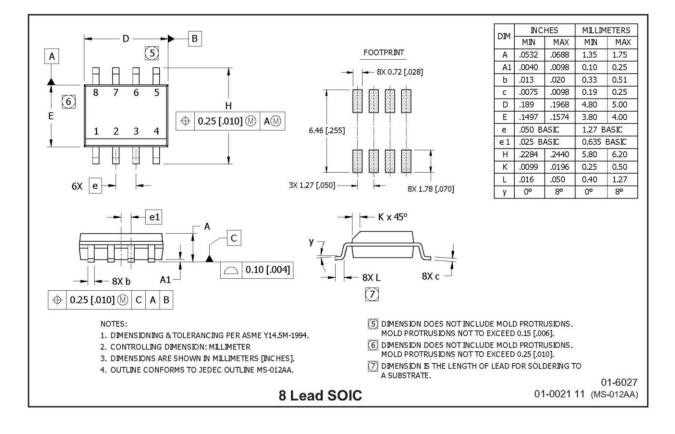






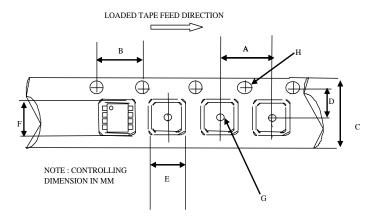


### **Package Details**



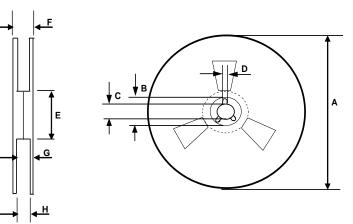


### **Tape and Reel Details**



#### CARRIER TAPE DIMENSION FOR 8SOICN

	Metric		Imp	erial
Code	Min	Max	Min	Max
A	7.90	8.10	0.311	0.318
В	3.90	4.10	0.153	0.161
С	11.70	12.30	0.46	0.484
D	5.45	5.55	0.214	0.218
E	6.30	6.50	0.248	0.255
F	5.10	5.30	0.200	0.208
G	1.50	n/a	0.059	n/a
Н	1.50	1.60	0.059	0.062

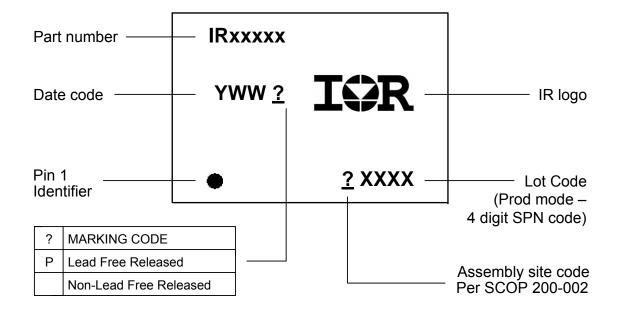


#### REEL DIMENSIONS FOR 8SOICN

	Me	etric	Imp	erial
Code	Min	Max	Min	Max
A	329.60	330.25	12.976	13.001
В	20.95	21.45	0.824	0.844
С	12.80	13.20	0.503	0.519
D	1.95	2.45	0.767	0.096
E	98.00	102.00	3.858	4.015
F	n/a	18.40	n/a	0.724
G	14.50	17.10	0.570	0.673
Н	12.40	14.40	0.488	0.566



#### **Part Marking Information**



#### **Qualification Information<sup>†</sup>**

	Industrial <sup>††</sup>
	(per JEDEC JESD 47)
Qualification Level	Comments: This family of ICs has passed JEDEC's
	Industrial qualification. IR's Consumer qualification level is
	granted by extension of the higher Industrial level.
Moisture Sensitivity Level	MSL2 <sup>†††</sup>
	(per IPC/JEDEC J-STD-020)
RoHS Compliant	Yes

- † Qualification standards can be found at International Rectifier's web site http://www.irf.com/
- ++ Higher qualification ratings may be available should the user have such requirements. Please contact your International Rectifier sales representative for further information.
- +++ Higher MSL ratings may be available for the specific package types listed here. Please contact your International Rectifier sales representative for further information.

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